

MC 1,5/ 2-G-3,5 WH - PCB header

1214228

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The figure shows a 10-position version

PCB headers, nominal cross section: 1.5 mm², color: white, nominal current: 8 A, rated voltage (III/2): 160 V, contact surface: Sn, contact connection type: Pin, number of rows: 1, number of positions: 2, product range: MC 1,5/..-G, pitch: 3.5 mm, mounting: Wave soldering, pin layout: Linear pinning, solder pin [P]: 3.4 mm, number of solder pins per potential: 1, plug-in system: COMBICON MC 1,5, Pin connector pattern alignment: Standard, locking: without, mounting method: without, type of packaging: packed in cardboard

Your advantages

- Well-known mounting principle allows worldwide use
- Maximum flexibility when it comes to device design – one header for connectors with different connection technologies

Commercial data

Item number	1214228
Packing unit	250 pc
Minimum order quantity	250 pc
Note	Made to order (non-returnable)
Product key	AABSAA
GTIN	4063151291587
Weight per piece (including packing)	0.5 g
Weight per piece (excluding packing)	0.443 g
Country of origin	DE

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Technical data

Product properties

Product type	PCB headers
Product family	MC 1,5/..-G
Product line	COMBICON Connectors S
Number of positions	2
Pitch	3.5 mm
Number of rows	1
Pin layout	Linear pinning
Solder pins per potential	1

Electrical properties

Properties

Nominal current I_N	8 A
Nominal voltage U_N	160 V
Rated voltage (III/3)	160 V
Rated surge voltage (III/3)	2.5 kV
Rated voltage (III/2)	160 V
Rated surge voltage (III/2)	2.5 kV
Rated voltage (II/2)	250 V
Rated surge voltage (II/2)	2.5 kV

Mounting

Mounting type	Wave soldering
Pin layout	Linear pinning

Material specifications

Material data - contact

Note	WEEE/RoHS-compliant, free of whiskers according to IEC 60068-2-82/JEDEC JESD 201
Contact material	Cu alloy
Surface characteristics	Tin-plated
Metal surface contact area (top layer)	Tin (3 μm - 5 μm Sn)
Metal surface contact area (middle layer)	Nickel (1.3 μm - 3 μm Ni)
Metal surface soldering area (top layer)	Tin (3 μm - 5 μm Sn)
Metal surface soldering area (middle layer)	Nickel (1.3 μm - 3 μm Ni)

Material data - housing

Color (Housing)	white (9010)
Insulating material	PA
Insulating material group	I
CTI according to IEC 60112	600

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Flammability rating according to UL 94	V0
Glow wire flammability index GWFI according to EN 60695-2-12	850
Glow wire ignition temperature GWIT according to EN 60695-2-13	775
Temperature for the ball pressure test according to EN 60695-10-2	125 °C

Dimensions

Dimensional drawing	
Pitch	3.5 mm
Width [w]	8.4 mm
Height [h]	10.65 mm
Length [l]	9.2 mm
Installed height	7.25 mm
Solder pin length [P]	3.4 mm
Pin dimensions	0.8 x 0.8 mm

PCB design

Hole diameter	1.2 mm
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Electrical tests

Air clearances and creepage distances |

Specification	IEC 60664-1:2007-04
Insulating material group	I
Comparative tracking index (IEC 60112)	CTI 600
Rated insulation voltage (III/3)	160 V
Rated surge voltage (III/3)	2.5 kV
minimum clearance value - non-homogenous field (III/3)	1.5 mm
minimum creepage distance (III/3)	2 mm
Rated insulation voltage (III/2)	160 V
Rated surge voltage (III/2)	2.5 kV
minimum clearance value - non-homogenous field (III/2)	1.5 mm
minimum creepage distance (III/2)	1.5 mm
Rated insulation voltage (II/2)	250 V
Rated surge voltage (II/2)	2.5 kV
minimum clearance value - non-homogenous field (II/2)	1.5 mm
minimum creepage distance (II/2)	1.5 mm

Environmental and real-life conditions

Ambient conditions

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Ambient temperature (storage/transport)	-40 °C ... 70 °C
Relative humidity (storage/transport)	30 % ... 70 %
Ambient temperature (assembly)	-5 °C ... 100 °C
Ambient temperature (operation)	-40 °C ... 100 °C (dependent on the derating curve)

Packaging specifications

Type of packaging	packed in cardboard
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Approvals

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 cULus Recognized Approval ID: E60425-20110128				
	Nominal voltage U_N	Nominal current I_N	Cross section AWG	Cross section mm^2
B	300 V	8 A	-	-
D	300 V	8 A	-	-

 VDE Zeichengenehmigung Approval ID: 40011723				
	Nominal voltage U_N	Nominal current I_N	Cross section AWG	Cross section mm^2
keine	160 V	8 A	-	-

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Classifications

ECLASS

ECLASS-13.0	27460201
ECLASS-15.0	27460201

ETIM

ETIM 10.0	EC002637
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UNSPSC

UNSPSC 21.0	39121400
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Environmental product compliance

EU RoHS

Fulfills EU RoHS substance requirements	Yes, No exemptions
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China RoHS

Environment friendly use period (EFUP)	EFUP-E
	No hazardous substances above the limits

EU REACH SVHC

REACH candidate substance (CAS No.)	No substance above 0.1 wt%
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